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Characterization with a β -source setup of the UFSD3.2 production manufactured at FBK

*16th “Trento” Workshop on Advanced Silicon Radiation Detectors,
2.18.2021*

Siviero F., Arcidiacono R., Cartiglia N., Costa M., Ferrero M., Mandurrino M., Menzio L., Milanesio M., Sola V., Staiano A., Tornago M., Borghi G., Boscardin M., Dalla Betta G-F., Ficorella F., Pancheri L., Paternoster G., Centis Vignali M.

Outline



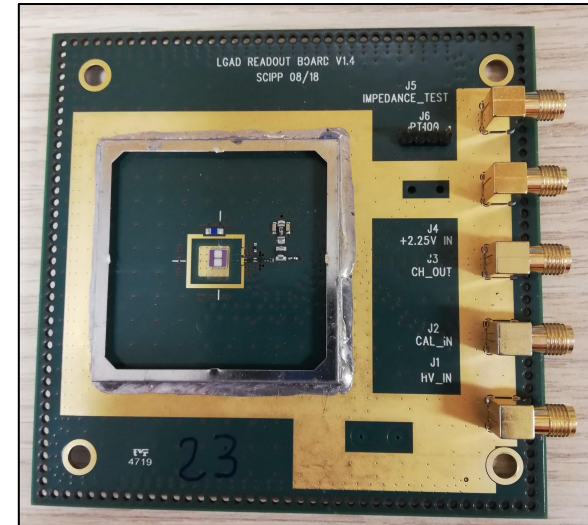
- FBK UFSD3.2 → 3 different Gain Layer designs
- Performance of pre-rad sensors
- Performance of irradiated sensors
- $V_{\text{irrad}}(10\text{fC})$ & $DV(10\text{fC})$
- A study on the noise of tested sensors

Outline



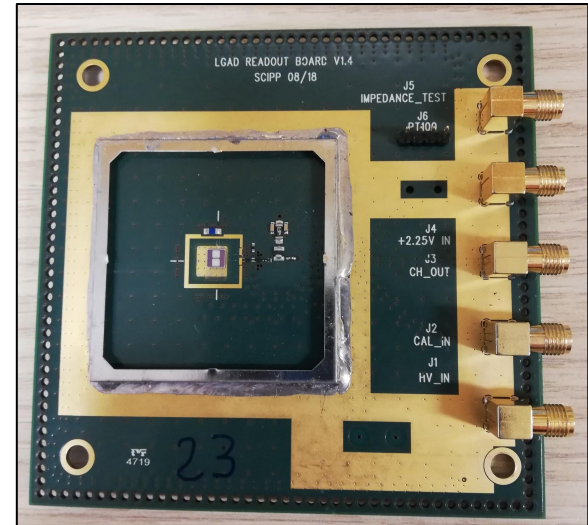
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- Latest LGAD production at FBK → aim at studying different Gain Layer (GL) designs
- Tested sensors are $1.3 \times 1.3 \text{ mm}^2$ single pads with $45 \text{ }\mu\text{m}$ active thickness
- Gain implants of tested devices are enriched with carbon → more on M.Ferrero's talk
- Read-out with "Santa-Cruz" board



A UFSD3.2 sensor mounted on a "Santa-Cruz" board

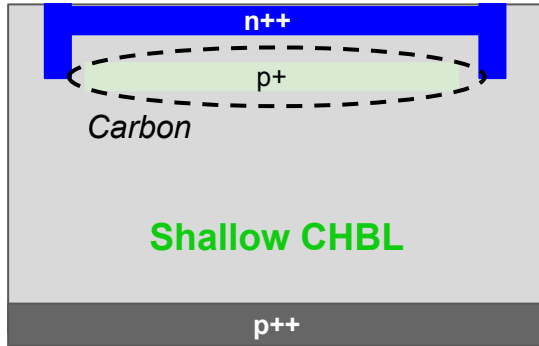
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A UFSD3.2 sensor mounted on a “Santa-Cruz” board

Goal of this talk is to discuss the characteristics of the 3 GL designs implemented in this production

Gain Layer designs

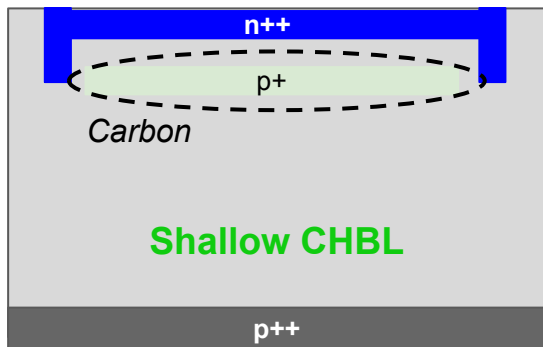


Shallow gain implant

(standard implant as previous
UFSD productions)

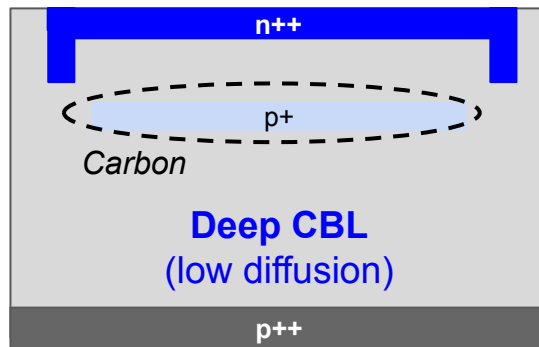
- W3, W7

Gain Layer designs



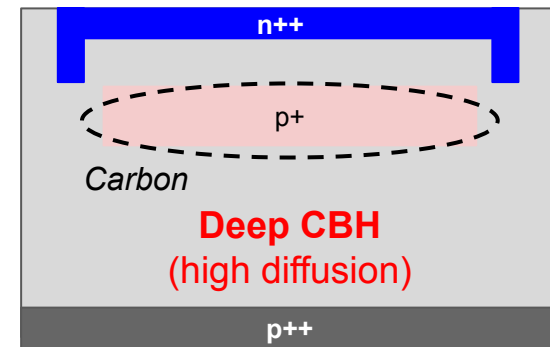
Shallow gain implant
(standard implant as previous
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- W3, W7



Deep CBL: diffusion at low
thermal load, narrow implant

- W10, W12, W13



Deep CBH: diffusion at high
thermal load, broad implant

- W14, W19

Deep gain implants improves the recovering power of VBias in irradiated sensors (see [N.Cartiglia's talk at 34th RD50 workshop](#))

G

Wafer	Thickness	GL depth	Pgain dose	Carbon dose	Diffusion
1	45 μm	standard	standard	A	CHBL
3	45 μm	standard	standard	0.8*A	CHBL
7	<u>55 μm</u>	standard	standard	A	CHBL
10	45 μm	deep	1	0.6*A	CBL
12	45 μm	deep	2	A	CBL
13	45 μm	deep	2	0.6*A	CBL
14	45 μm	deep	2	A	CBH
15	<u>55 μm</u>	deep	2	A	CBH
18	45 μm	deep	3	A	CBH
19	45 μm	deep	3	0.6*A	CBH

shallow

deep CBL

2 Pgain doses
2 carbon doses

deep CBH

2 Pgain doses
2 carbon doses

increasing dose

ble

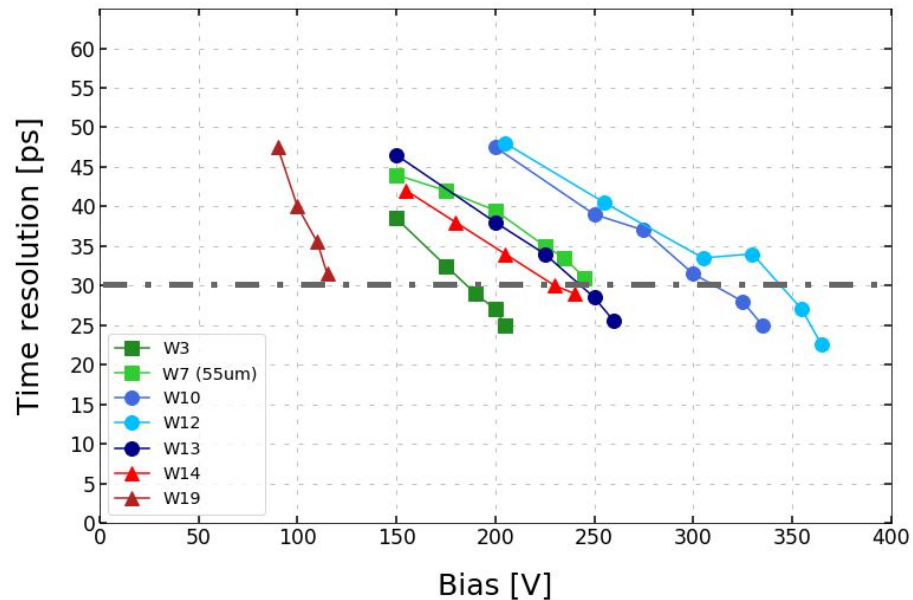
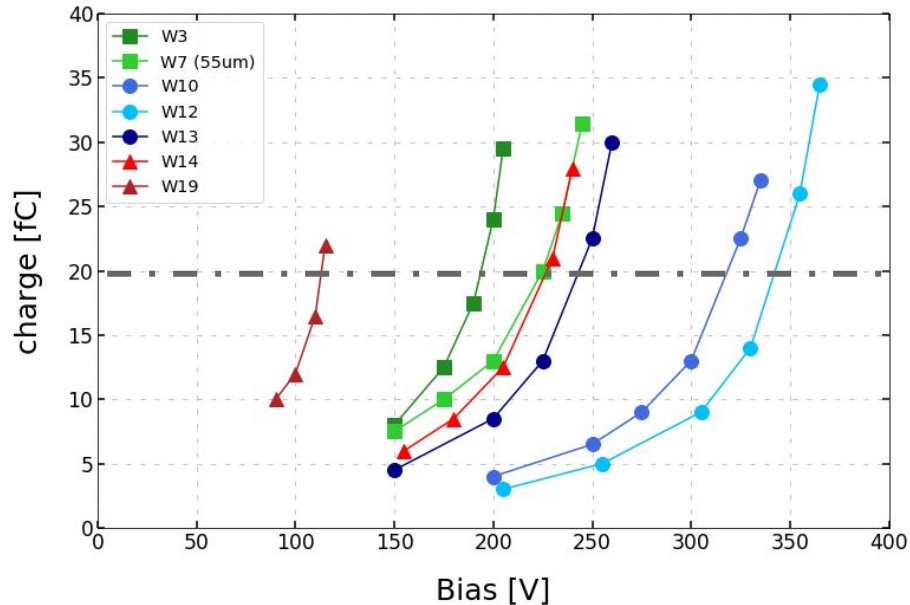


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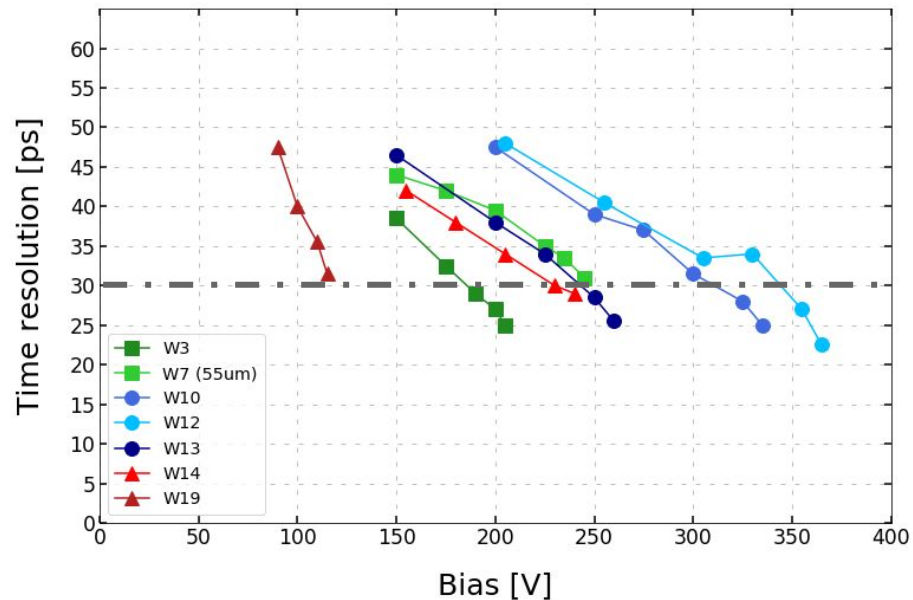
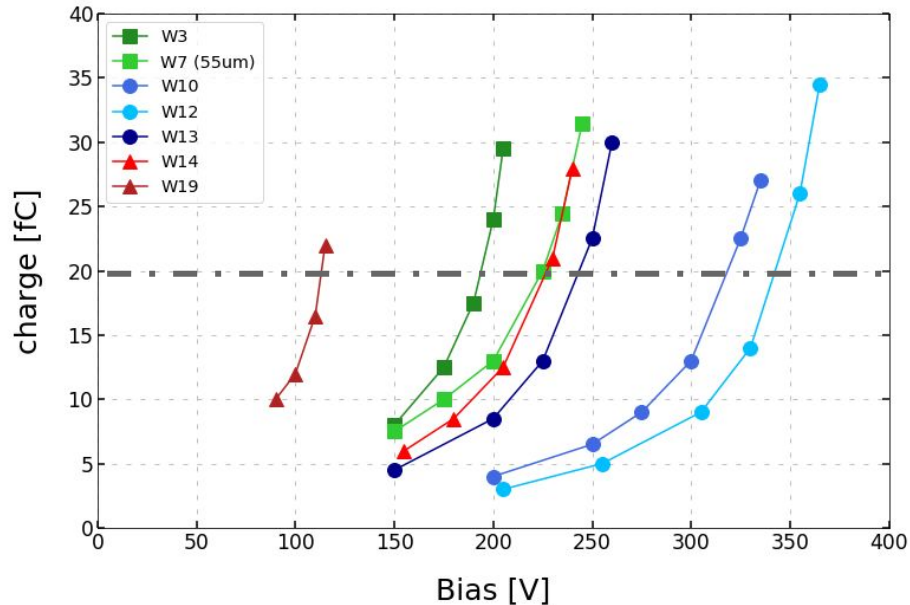
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measurements performed at $-25\text{ }^{\circ}\text{C}$



- Excellent performances of all sensors:
 - Delivered charge $> 20\text{fC}$
 - Time resolution $\sim 30\text{ps}$

measurements performed at $-25\text{ }^{\circ}\text{C}$

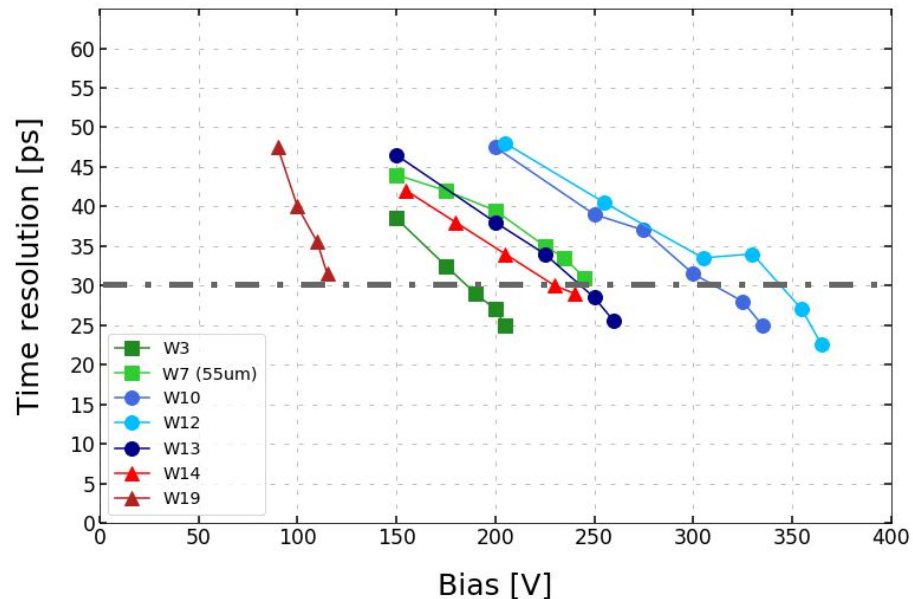
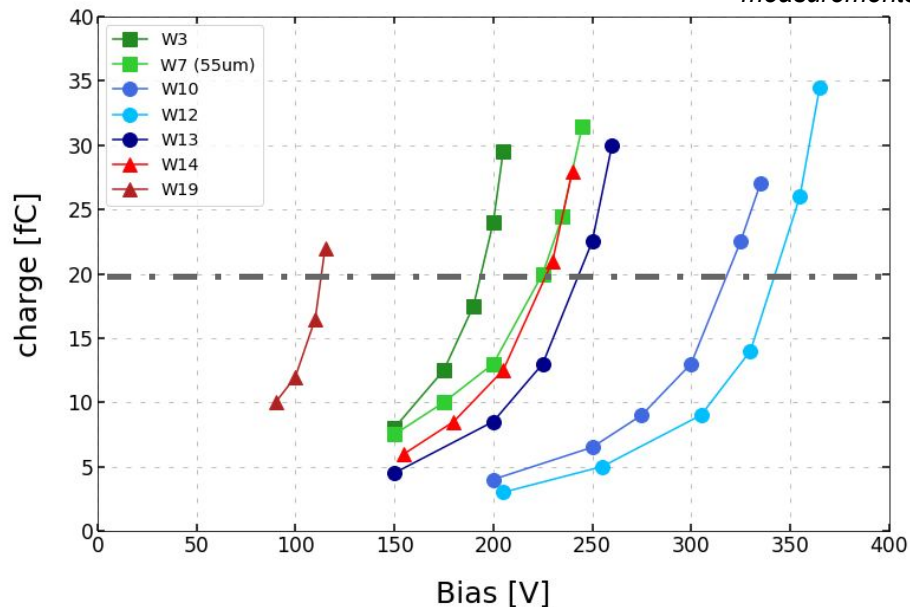


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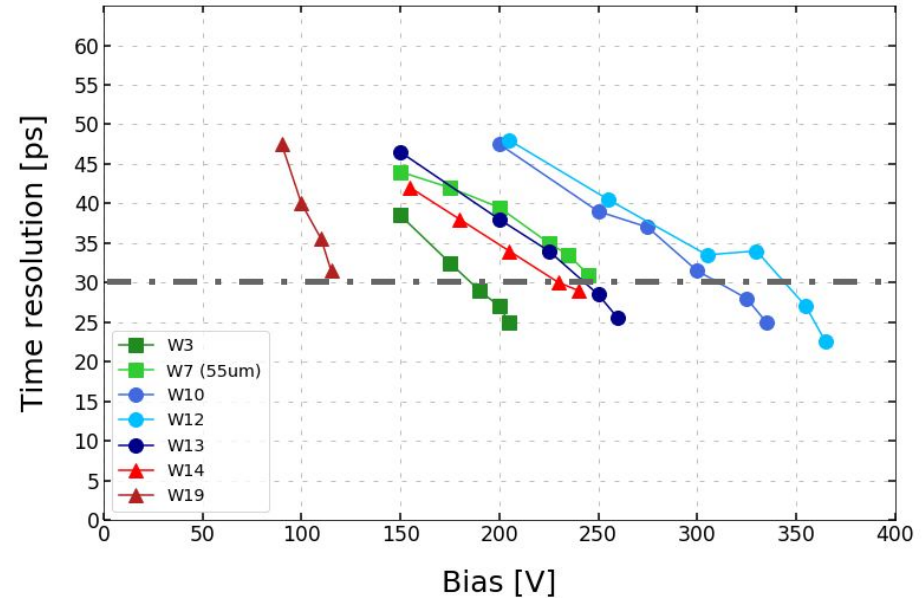
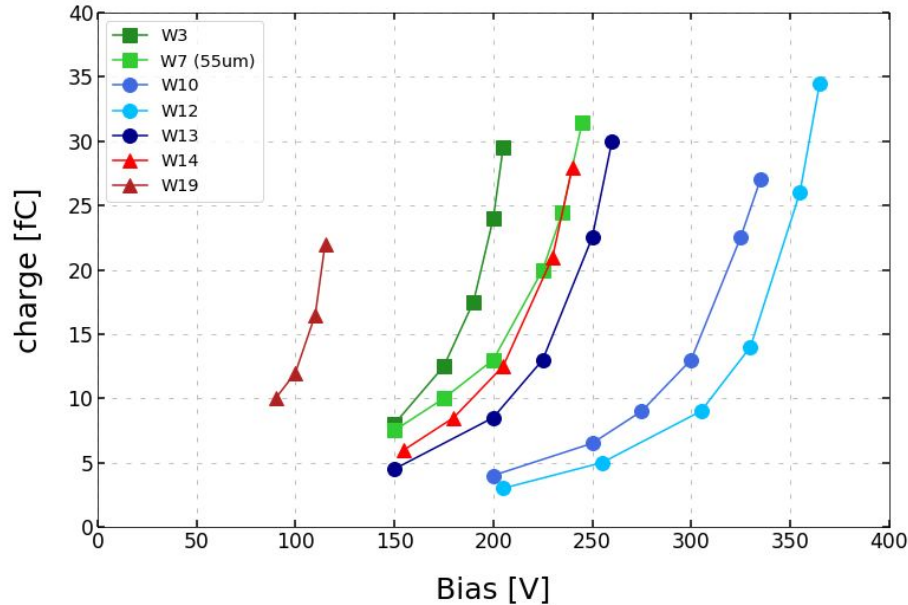
are they all equivalent?

measurements performed at $-25\text{ }^{\circ}\text{C}$



- We assess the performances of UFSD designs by looking at the collected charge and time resolution → but **all these sensors have very similar performances**, although they are not equal
- In the following, I will show what is the best way to discriminate between these designs

measurements performed at $-25\text{ }^{\circ}\text{C}$

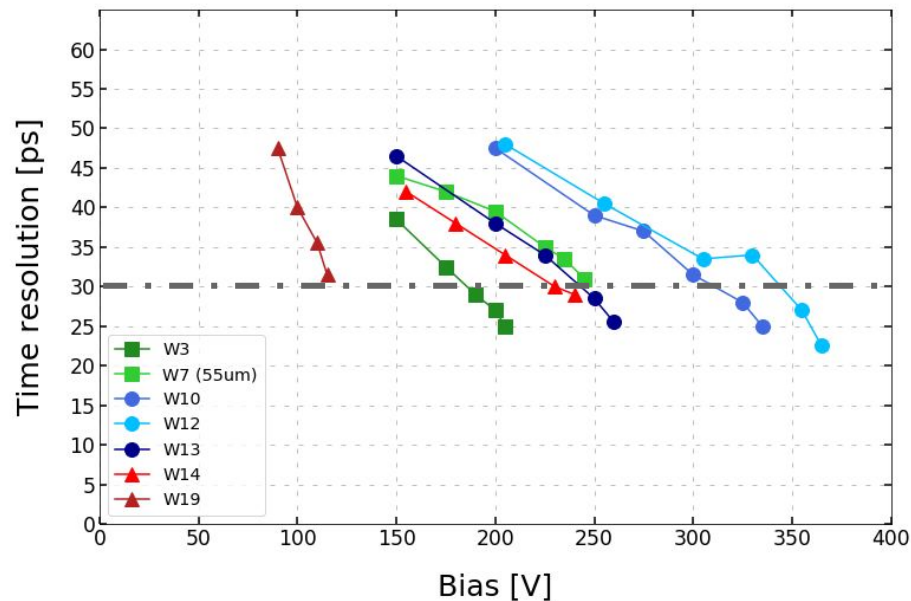
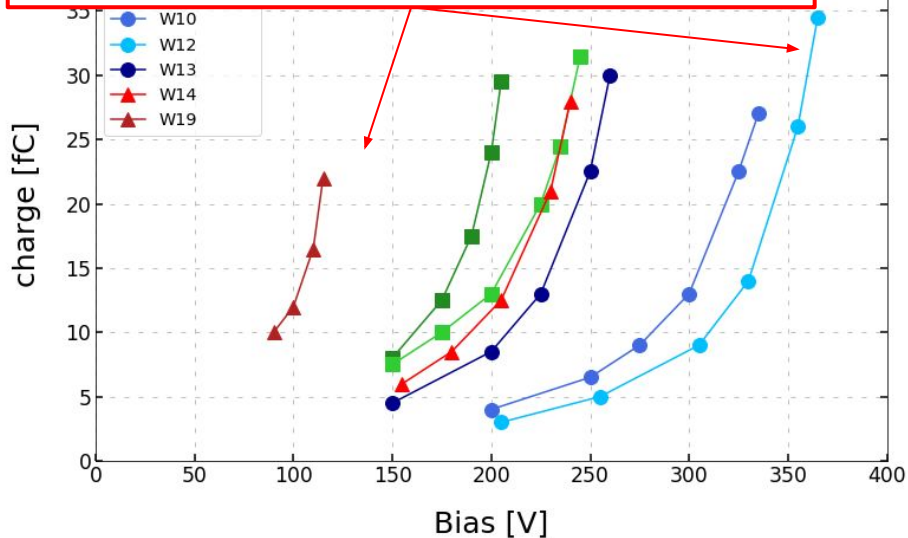


- For pre-rad sensors, the figures of merit can be the operating voltage and the steepness of the gain curve
 - High operating voltage → Carriers drift velocity saturated
 - Smooth gain curve → non uniformities between sensors affect performances less

Performances of pre-rad sensors

These two aspects are related: sensors with low breakdown voltage have steep curves

Measurements performed at $-25\text{ }^{\circ}\text{C}$

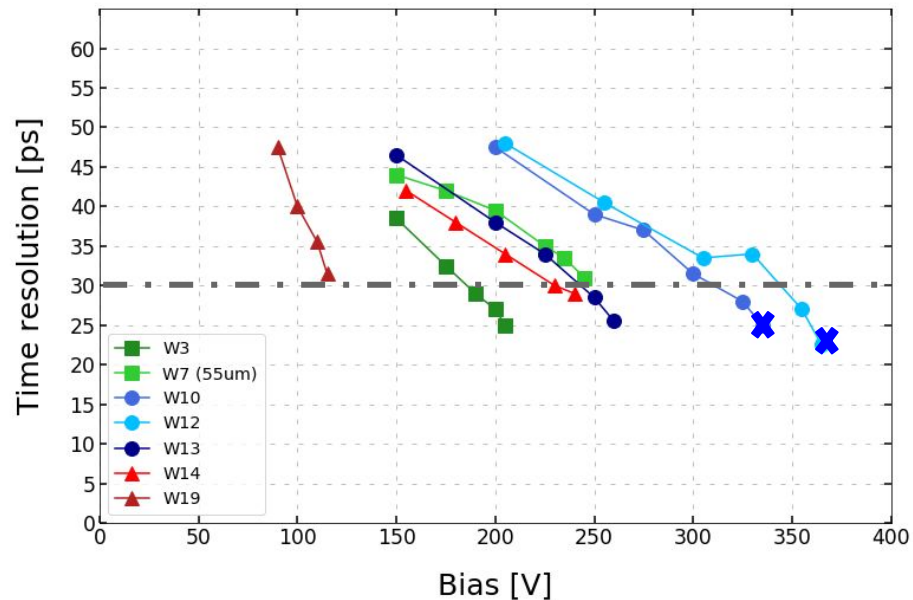
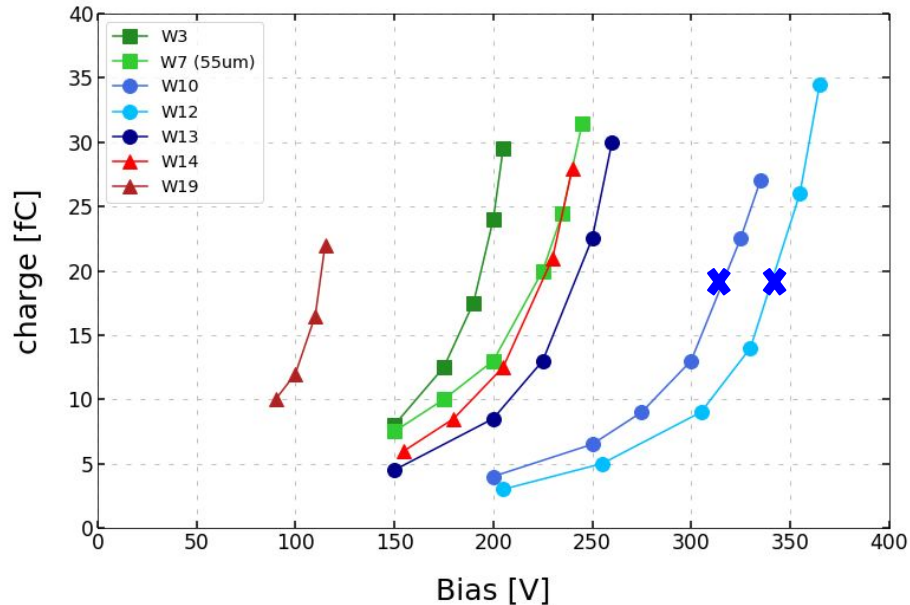


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Performances of pre-rad sensors

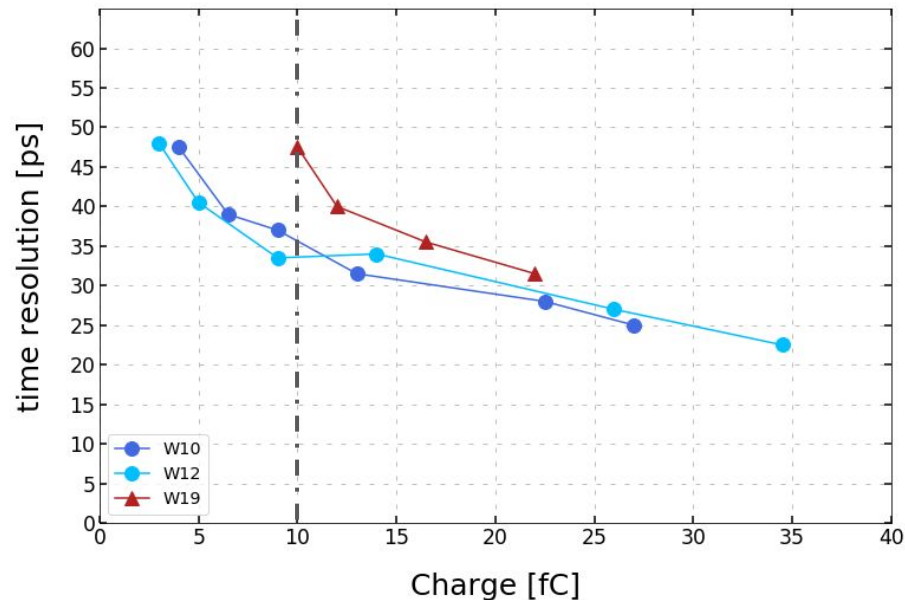
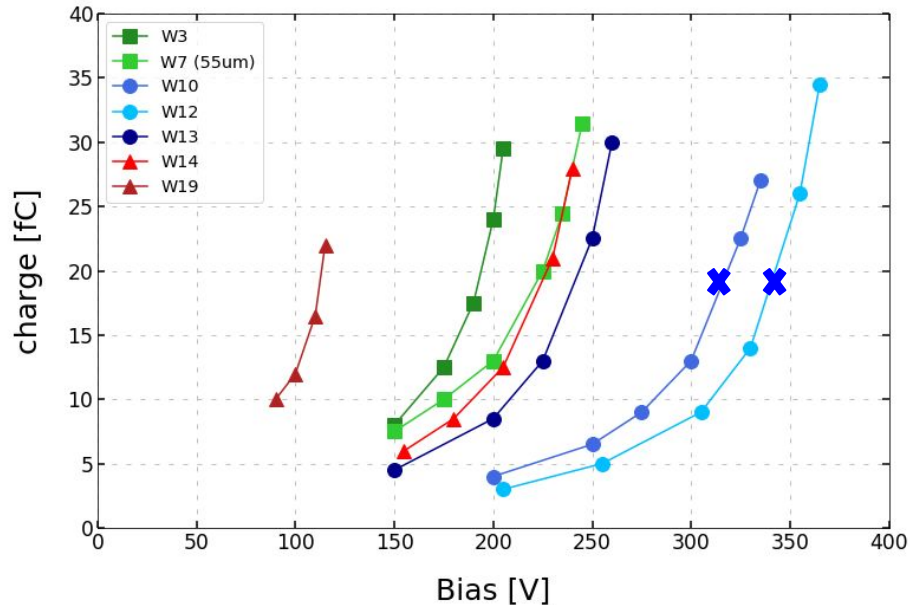


measurements performed at $-25\text{ }^{\circ}\text{C}$



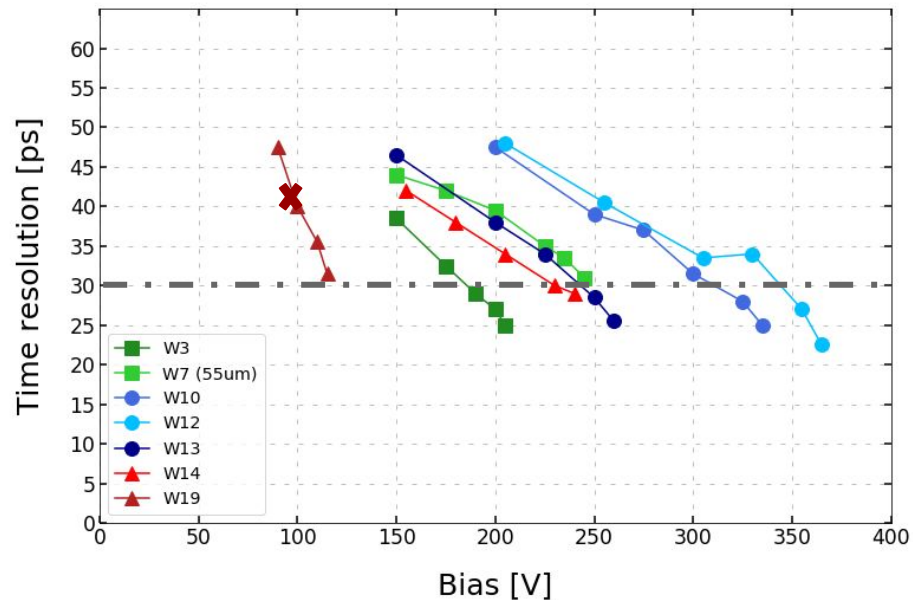
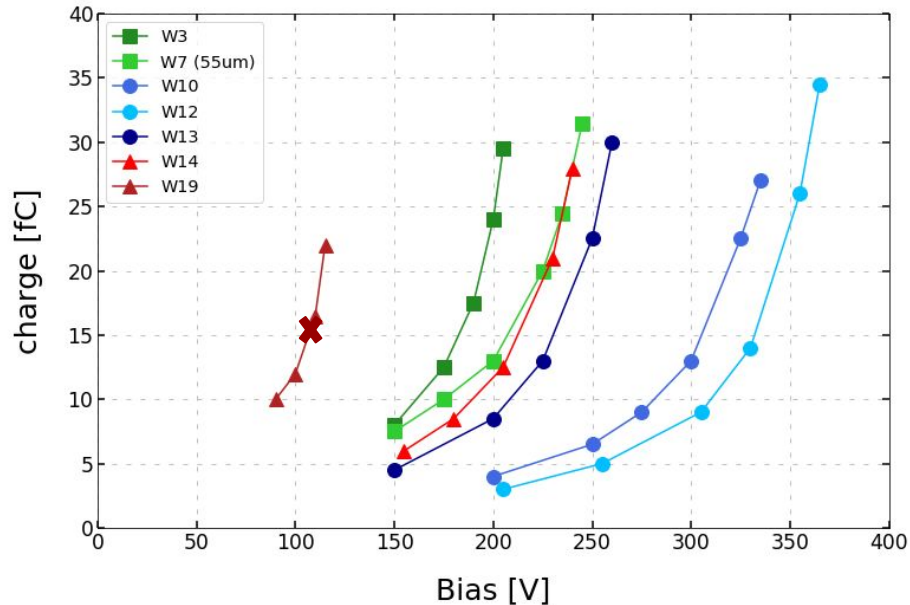
- **W10, W12 (CBL) ideal when new** → low Pgain dose

measurements performed at -25 °C



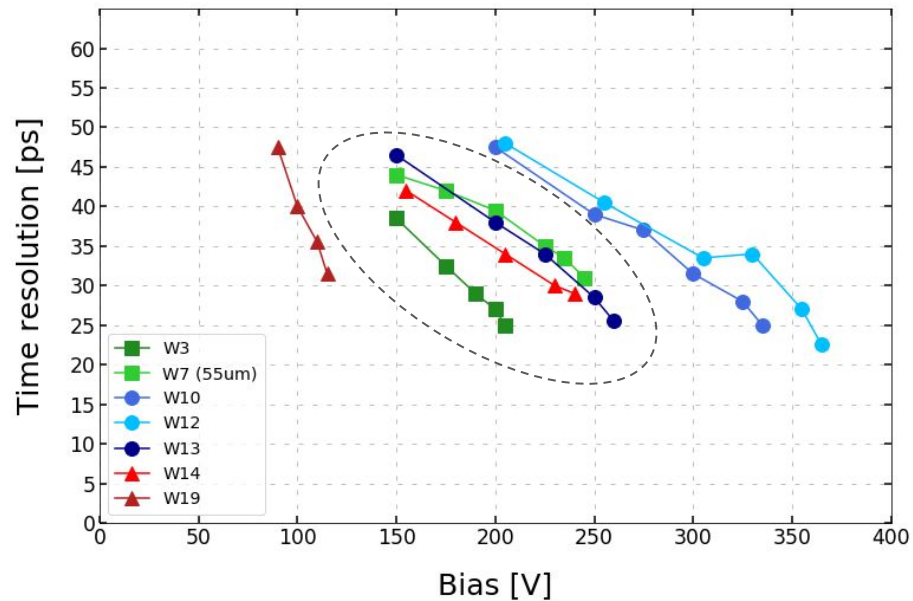
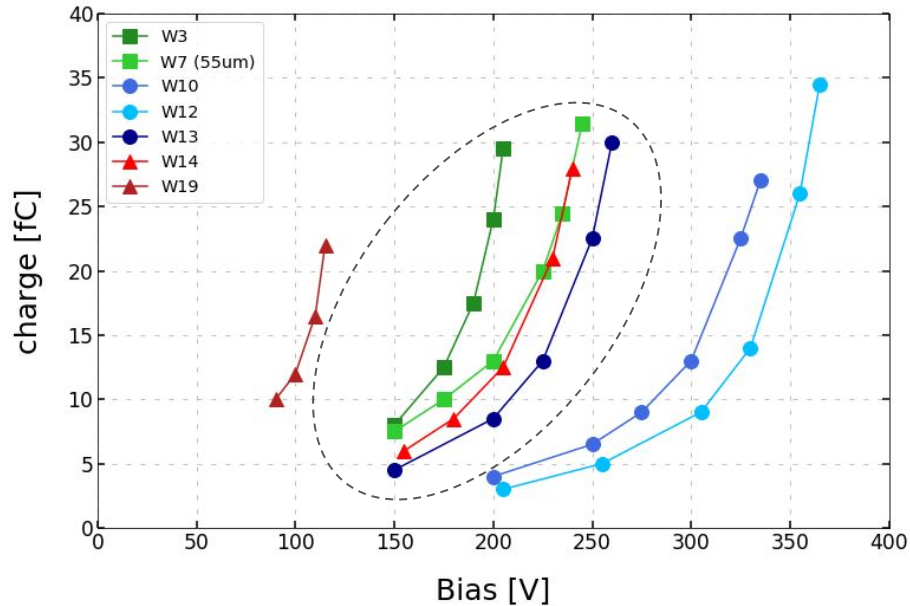
- **W10, W12 (CBL) ideal when new** → low Pgain dose
 - For a given gain/charge → the higher Vbias, the better the time resolution is

measurements performed at $-25\text{ }^{\circ}\text{C}$



- **W19 (CBH) has very high doping, not the best pick when new**
 - Step gain curve \rightarrow hard to operate several sensors with same performances
 - Carriers drift velocity not saturated (or just close to saturation) \rightarrow can barely reach 30ps

measurements performed at $-25\text{ }^{\circ}\text{C}$



- **W 3, 7, 13, 14** in between \rightarrow work well when new, although not the best

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- **Performance of irradiated sensors**
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Irradiated sensors

All wafers have been irradiated at JSI TRIGA reactor → fluences: $8e14$, $1.5e15$, $2.5e15$ n_{eq}/cm^2

c : inverse of the fluence
after which the GL initial
acceptor density is reduced
by a factor e

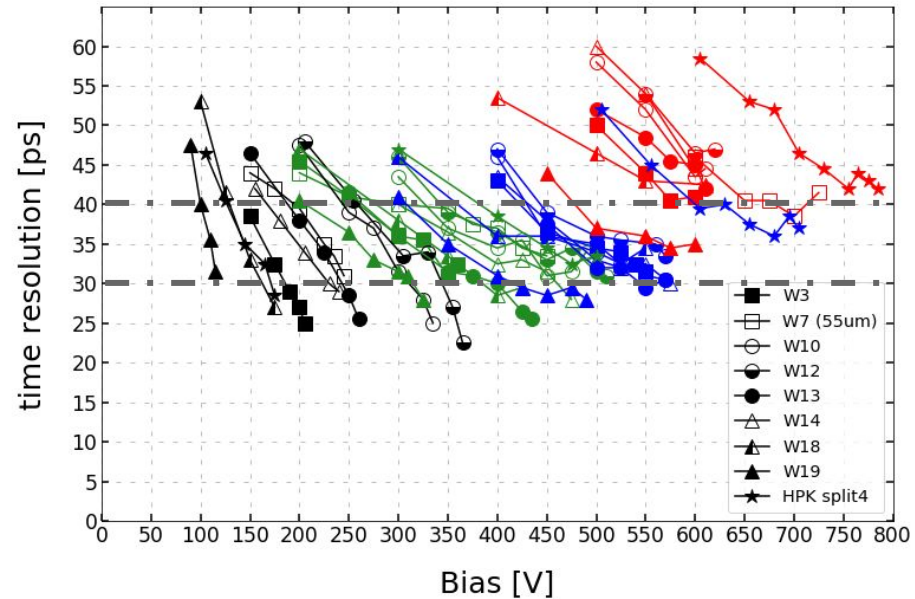
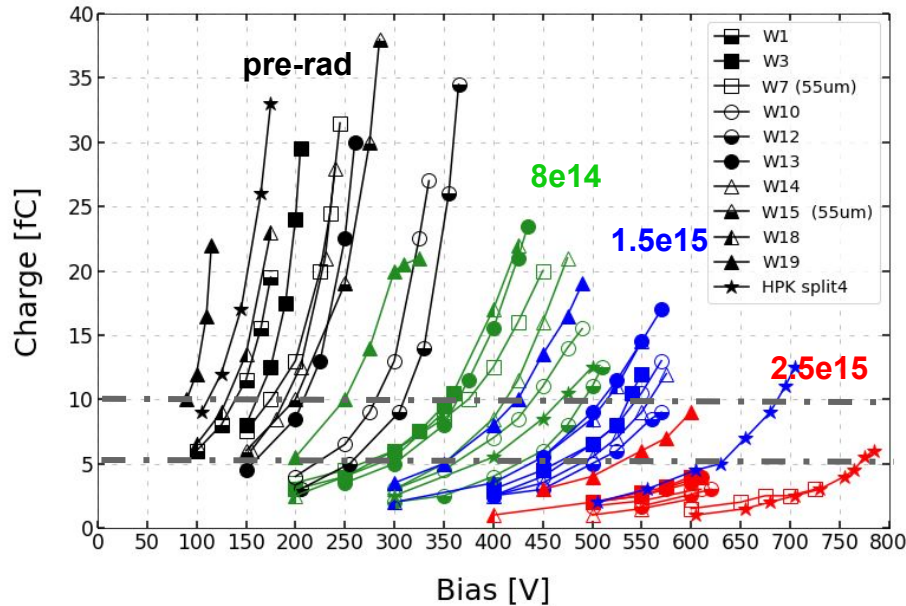
Wafer	Pgain dose	Carbon dose	c coeff. [$10^{-16} cm^2$]	
3	std	A	1,48	shallow
7	std	A	1,91	
10	1	0.6*A	2,16	deep CBL
12	2	A	2,06	
13	2	0.6*A	1,63	
14	2	A	2,45	deep CBH
19	3	0.6*A	1,9	

Details on UFSD3.2 radiation resistance in M.Ferrero's talk

Charge vs Bias

measurements performed at -25°C

Time resolution vs Bias

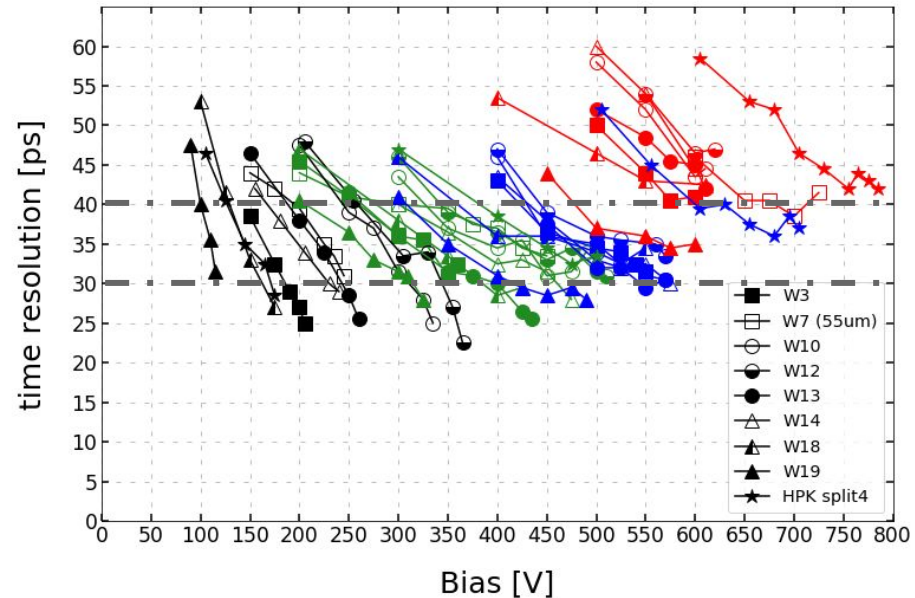
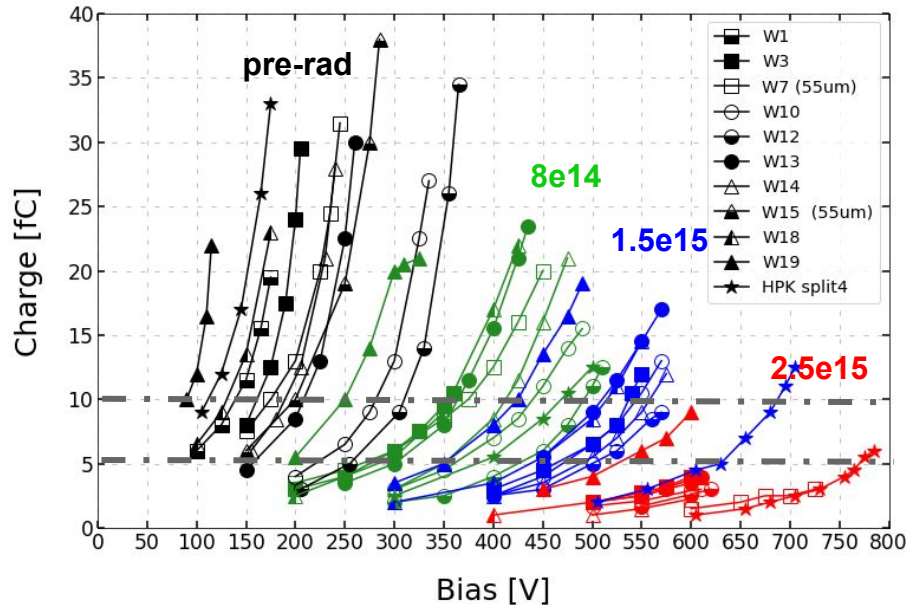


- All sensors deliver ≥ 10 fC up to $1.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ (~ 5 fC at 2.5×10^{15})
- **30 ps** are reached by all tested sensors up to 1.5×10^{15} (~ 40 ps at 2.5×10^{15})

Charge vs Bias

measurements performed at -25°C

Time resolution vs Bias



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- **30 ps are reached by all tested sensors up to 1.5×10^{15}** (~ 40 ps at 2.5×10^{15})

all sensors fulfill the desired criteria \rightarrow need to define new figures of merit to discriminate between them

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$V_{\text{irrad}}(10\text{fC})$ & $DV(10\text{fC})$

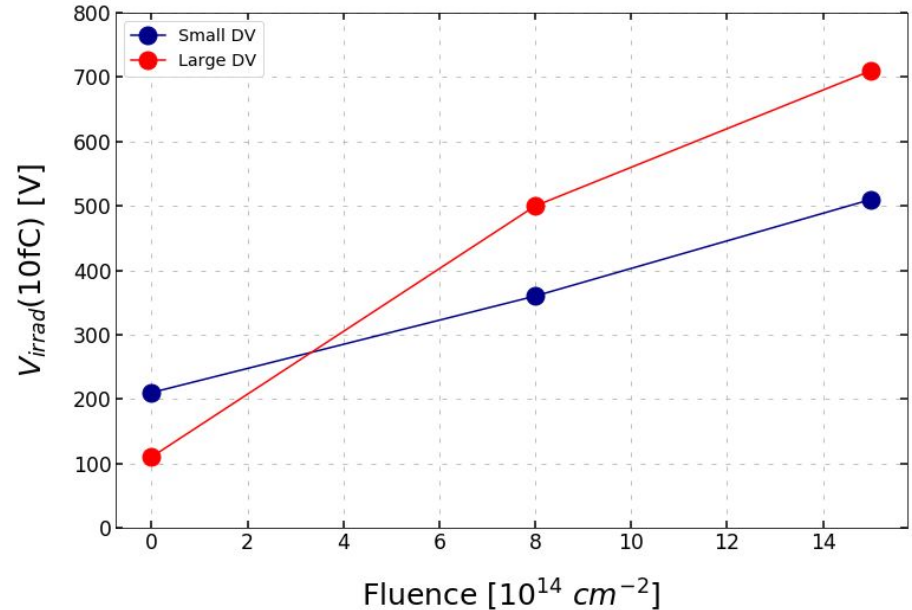


- What do we look for in an irradiated sensor? (provided it achieves the desired resolution)
 - **Operation at low VBias**
 - **VBias increase to compensate radiation effects as low as possible**
- We can introduce two additional useful parameters to evaluate irradiated sensors:
 - **VBias required to deliver 10fC at a given fluence** $\rightarrow V_{\text{irrad}}(10\text{fC})$
 - **VBias increase wrt pre-rad condition** $\rightarrow DV(10\text{fC}) = V_{\text{irrad}}(10\text{fC}) - V_{\text{pre-rad}}(10\text{fC})$
- The smaller such parameters, the better the GL design

$V_{\text{irrad}}(10\text{fC})$ & $DV(10\text{fC})$



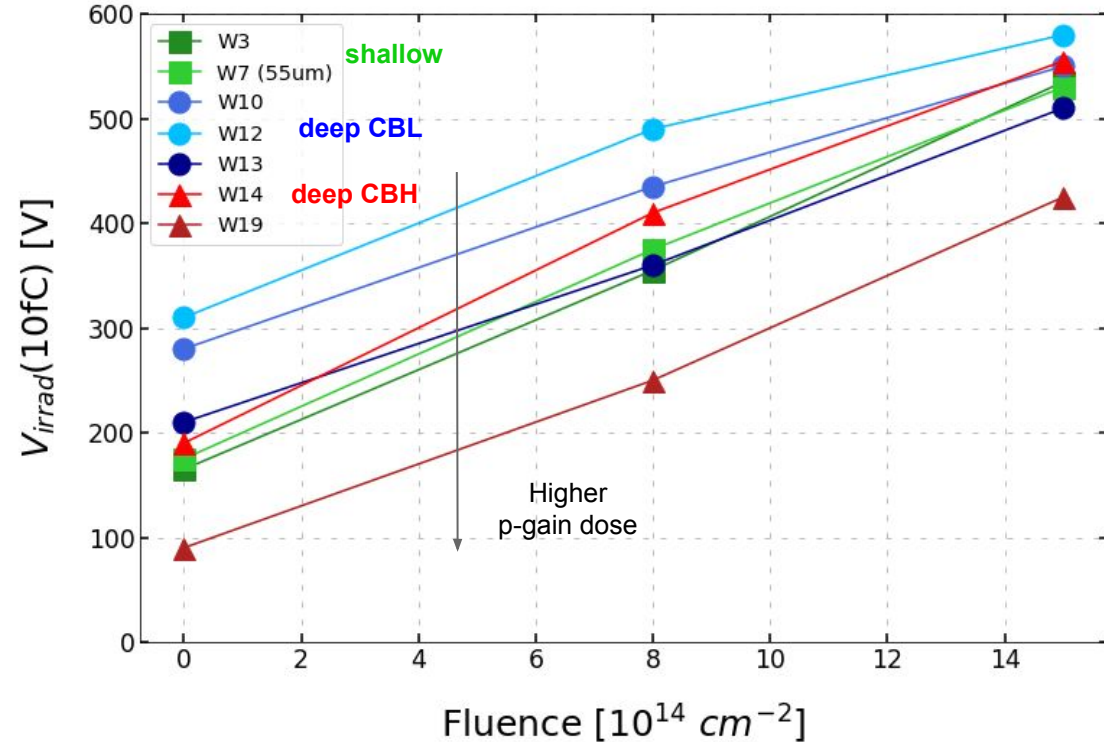
- Small $V_{\text{irrad}}(10\text{fC})$ = low power consumption, safe operation of the device
- Small $DV(10\text{fC})$ = less affected by non-uniform irradiation → V_{Bias} shift to compensate a variation in fluence is smaller in sensors with small DV



$V_{\text{irrad}}(10\text{fC})$



measurements performed at $-25\text{ }^{\circ}\text{C}$

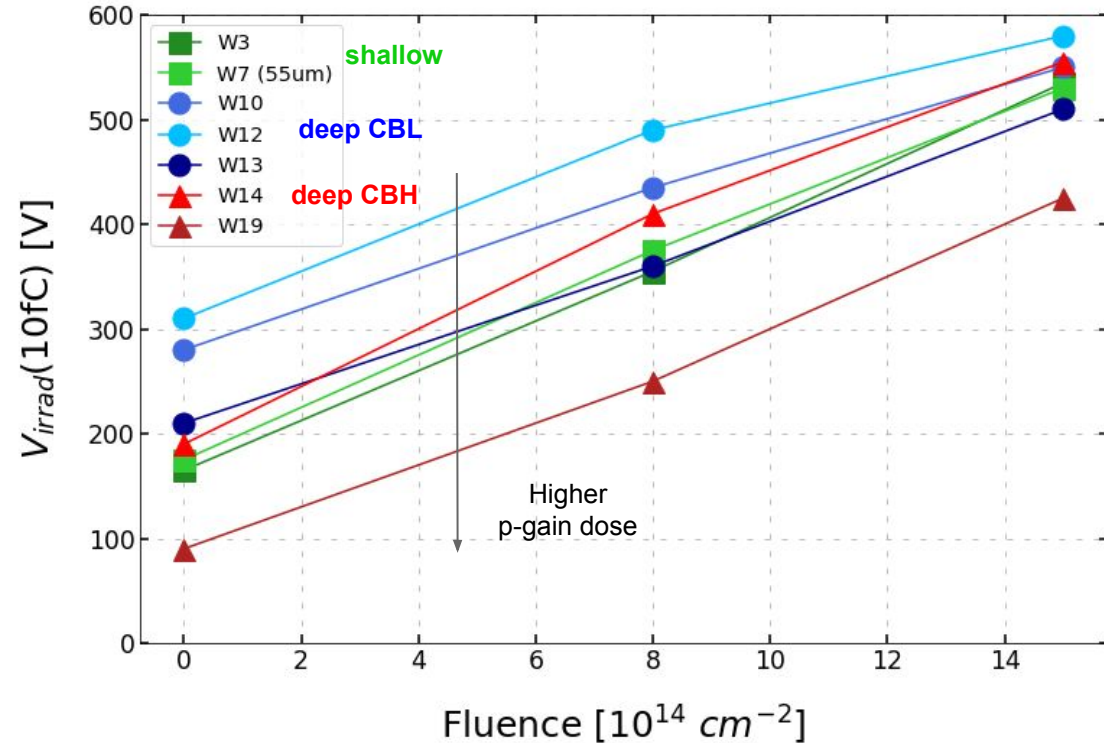


- The higher the initial doping, the lower $V_{\text{irrad}}(10\text{fC})$
- **W19 (deep CBH)** has the lowest V_{irrad} but poor performance when new
- **W13 (deep CBL)** has higher V_{irrad} but works well when new

$V_{\text{irrad}}(10\text{fC})$



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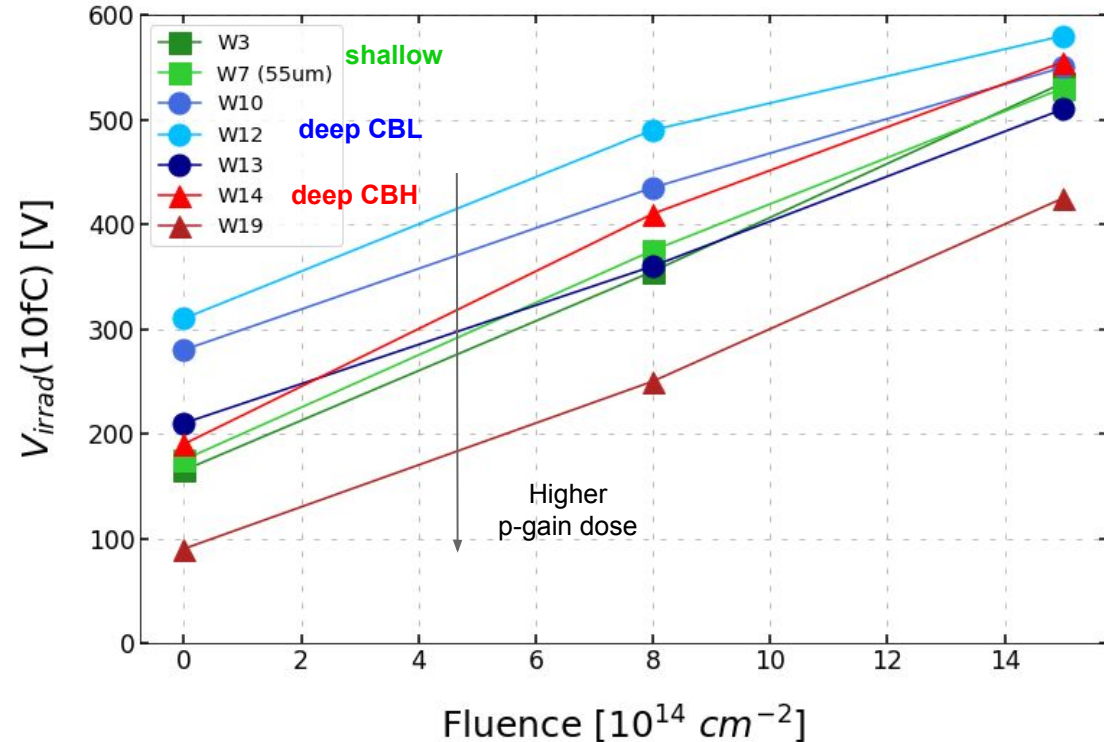


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- **High doping + deep implants provide the best $V_{\text{irrad}}(10\text{fC})$**

$V_{\text{irrad}}(10\text{fC})$

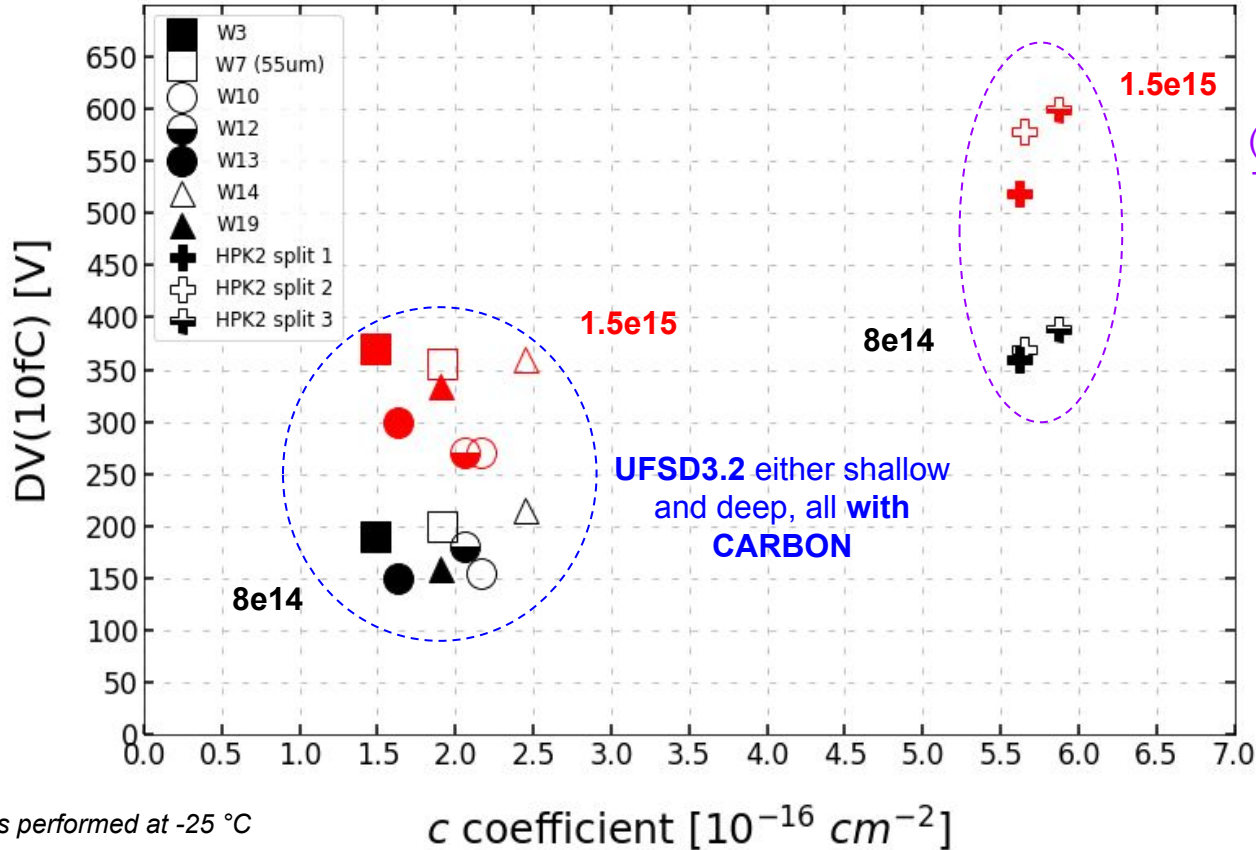


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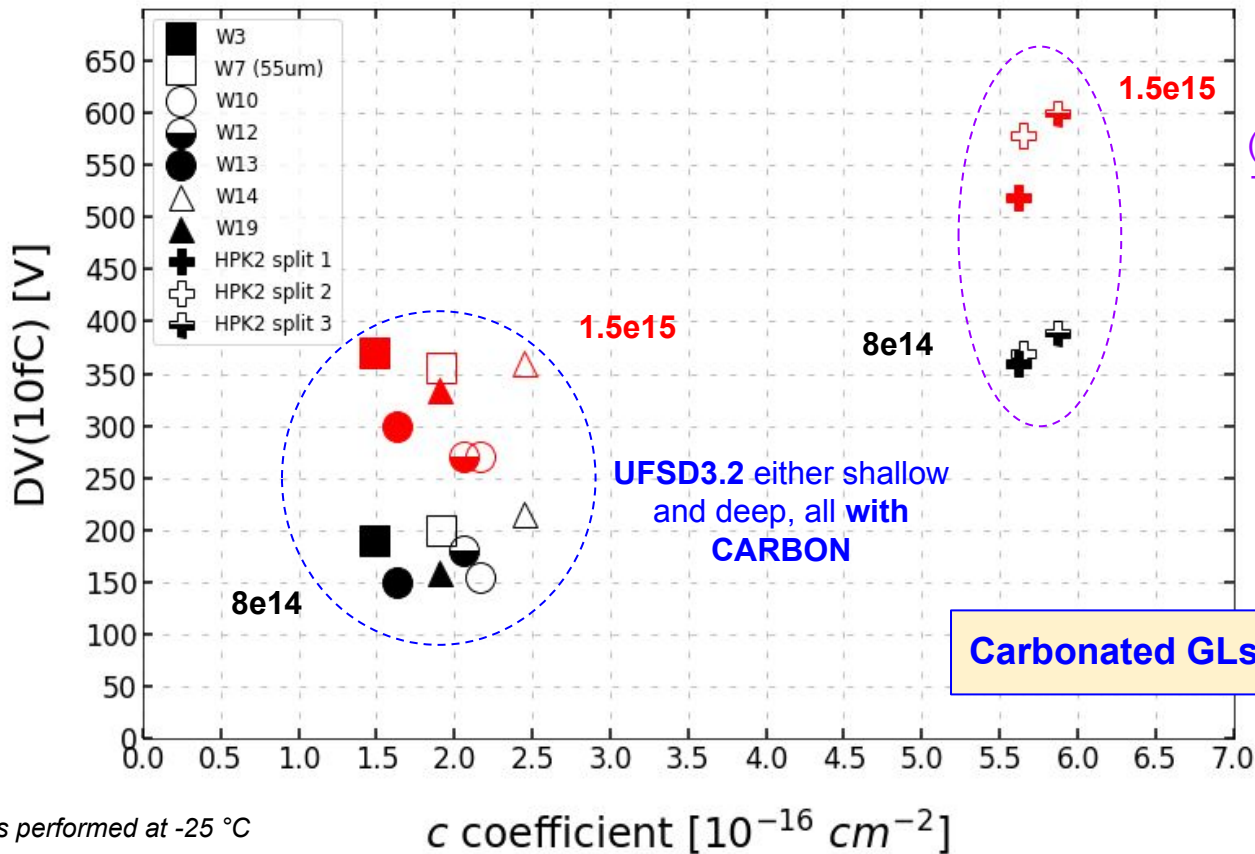
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- **High doping + deep implants provide the best $V_{\text{irrad}}(10\text{fC})$**
- **a too high doping affect the performances when new**

DV(10fC)



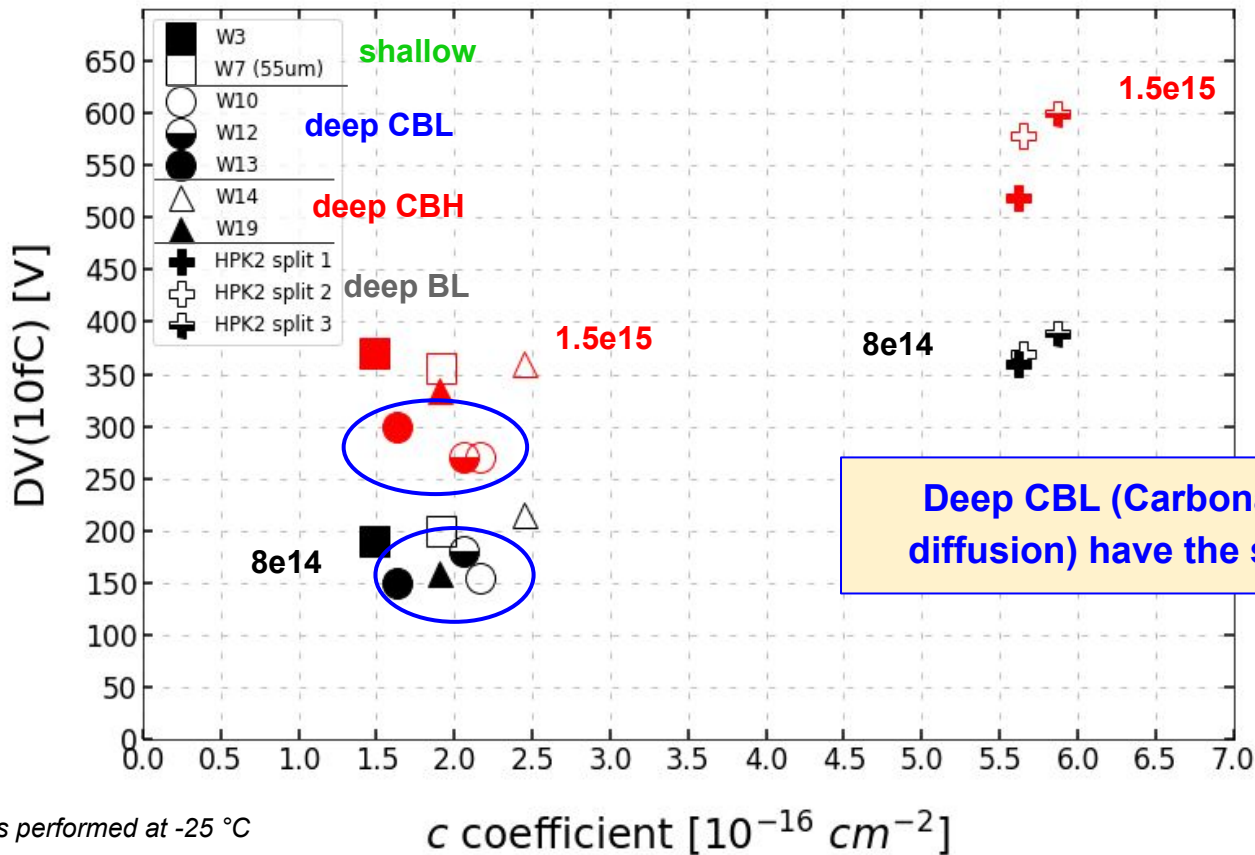
measurements performed at -25 °C

DV(10fC)



measurements performed at -25 °C

DV(10fC)



Most radiation resistant design



- All UFSD3.2 sensors have very good radiation hardness and reach 30-40 ps up to high fluences
- $V_{\text{irrad}}(10\text{fC})$ and $DV(10\text{fC})$ are effective figures of merit:
 - Deep and highly doped implants have the lowest $V_{\text{irrad}}(10\text{fC})$
 - Carbonated GL have much lower DV than not-carbonated
 - Deep implants have lower DV than shallow
 - Deep Low diffusion implants have lower DV than High diffusion ones

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 - Deep implants have lower DV than shallow
 - Deep Low diffusion implants have lower DV than High diffusion ones
- Summing up the above points → we conclude that the **Carbonated deep Gain Layer with low diffusion (CBL) is the most radiation resistant design in the UFSD3.2 production**

Outline



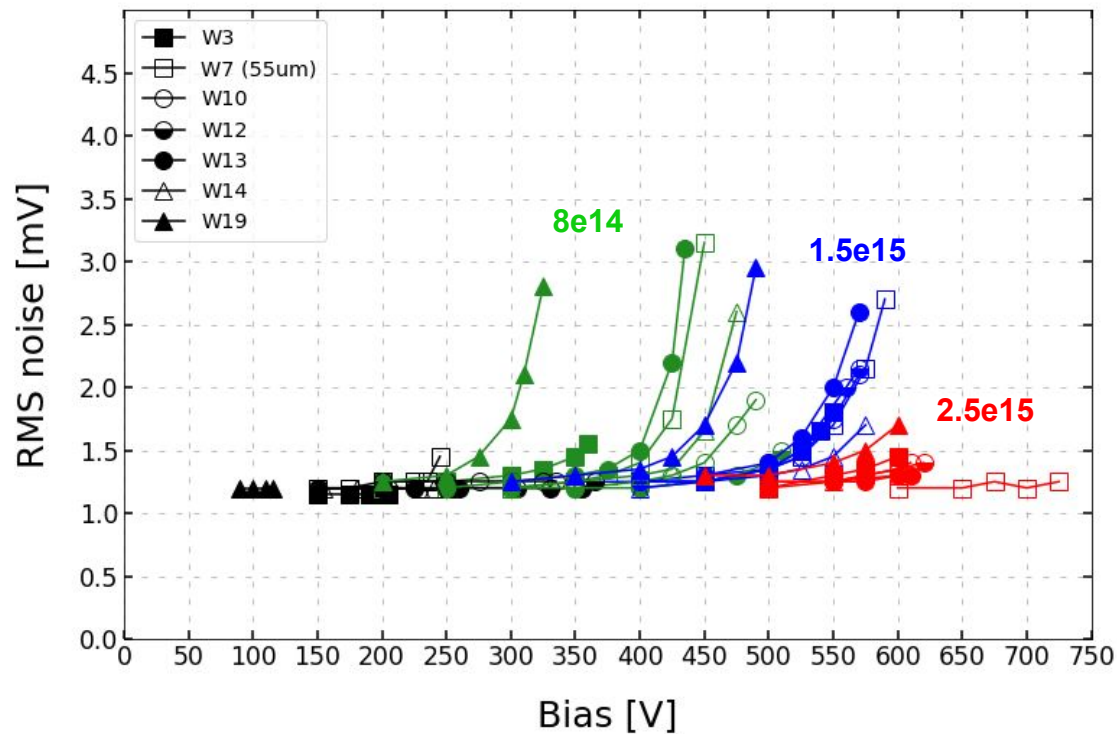
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Noise vs Bias: irradiated sensors



- “Santa-Cruz” read-out board noise ~ 1.2 mV
- High noise appears at high gain in irradiated devices

measurements performed at -25 °C

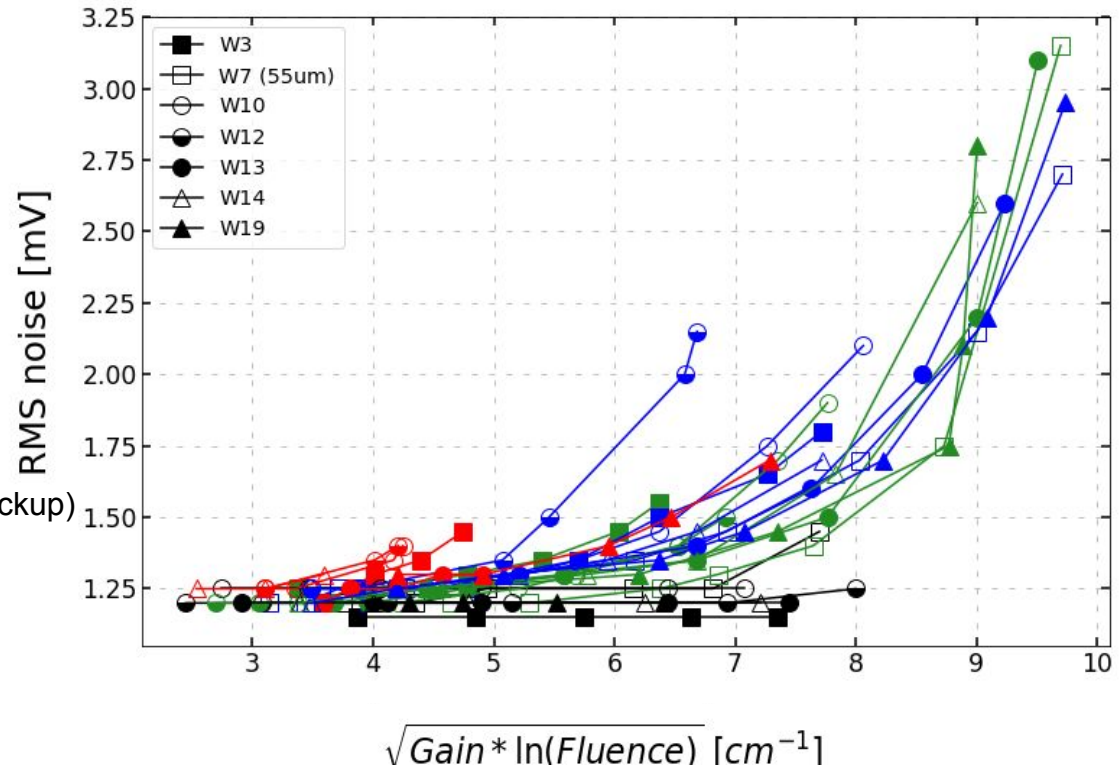


Noise vs Bias: irradiated sensors



measurements performed at -25 °C

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- There is a common trend when plotting *noise vs sqrt(gain*ln(flucence))*
 - Noise $\propto \text{sqrt}(\text{current})$
 - current $\propto \text{gain} * \ln(\text{flucence})$
- noise does not depend significantly on the GL design
- $\ln(\text{flucence})$ reproduces better than *flucence* (backup)



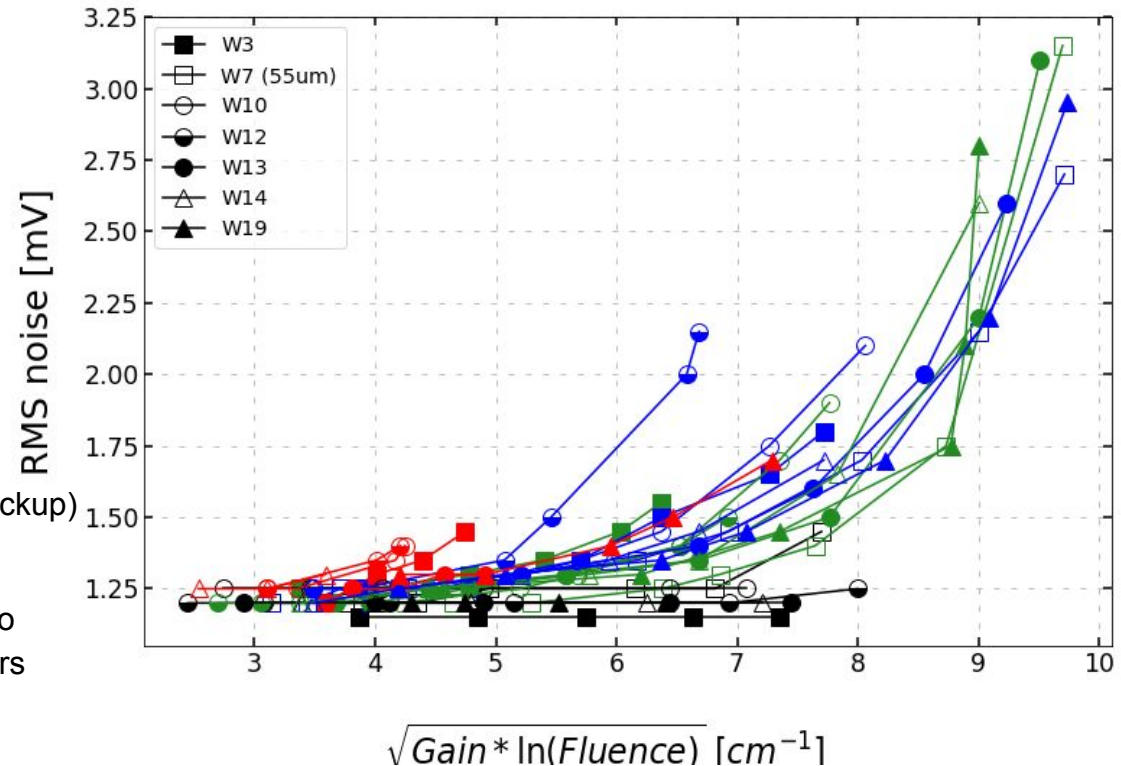
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- $\ln(\text{flucence})$ reproduces better than *flucence* (backup)
- Noise > read-out noise when:
 $\text{sqrt}(\text{gain} * \ln(\text{flucence})) \geq 5 \rightarrow$ useful indication to prevent large noise when operating the sensors

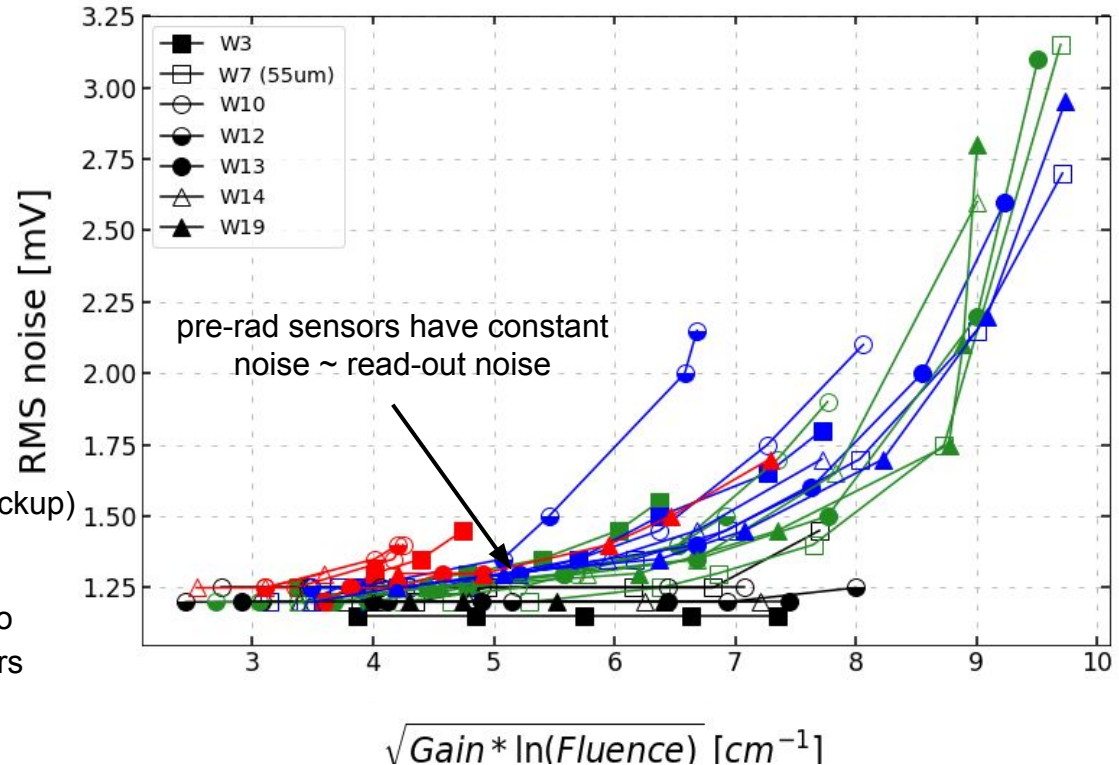


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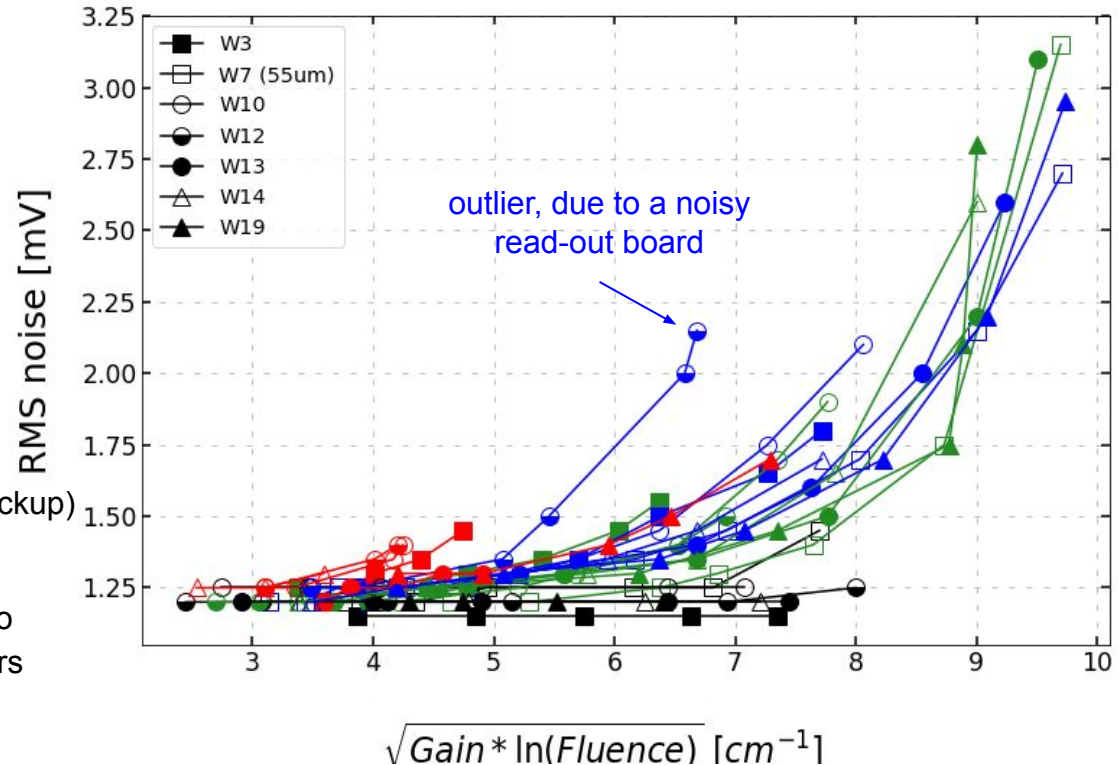


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Conclusions



- **The UFSD3.2 production features 3 different Gain Layer (GL) designs:**
 - Shallow (standard) carbonated GL
 - Deep carbonated GL with low diffusion → “CBL”
 - Deep carbonated GL with high diffusion → “CBH”
- **Key point: the gain layer design has to be tailored to the specific application** → no design fits all needs
- **Time resolution and radiation hardness are excellent for all sensors** → 30-40 ps up to $2.5e15 n_{eq}/cm^2$
 - Need to find the figures of merit to discriminate the various designs
- **Pre-rad sensors: look for operation at high voltage** (saturated fields, smooth gain curves) → low P_{gain} dose
- **Irradiated sensors: Deep Carbonated GL with low diffusion (CBL) are presently the most radiation resistant design**
 - Operated at the lowest V_{Bias} and require the smallest increase of voltage to compensate the effects of radiations
- Very high noise appears at high gain in irradiated sensors
 - It does not depend on the GL design
 - Seems to be a threshold effect depending on the sensor gain and log of the fluence

Thank You!

Acknowledgements

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- ▷ Horizon 2020, grant UFSD669529
- ▷ Horizon 2020, grant INFRAIA
- ▷ AIDA-2020, grant agreement no. 654168
- ▷ INFN, Gruppo V
- ▷ Ministero degli Affari Esteri, Italy, MAE, “Progetti di Grande Rilevanza Scientifica”
- ▷ MIUR, Dipartimenti di Eccellenza (ex L. 232/2016, art. 1, cc. 314, 337)
- Ministero della Ricerca, Italia , PRIN 2017, progetto 2017L2XKTJ – 4DinSiDe
- Ministero della Ricerca, Italia, FARE, R165xr8frt_fare

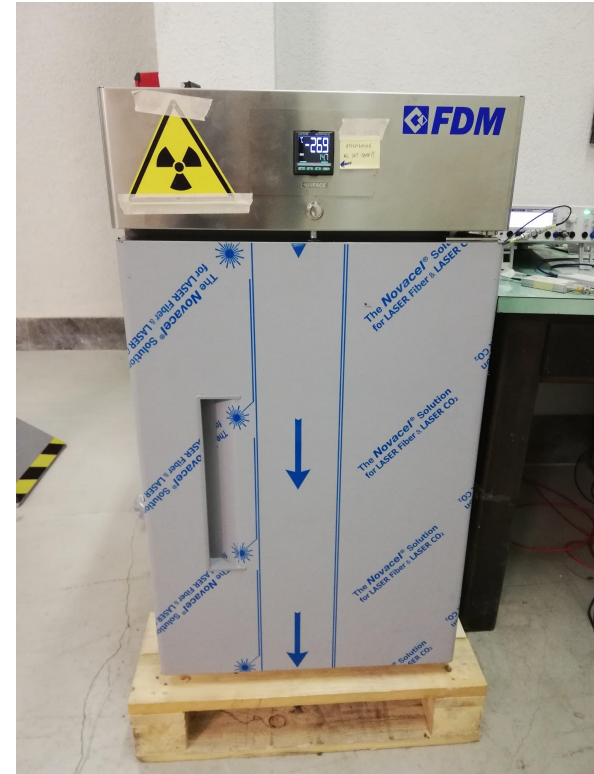
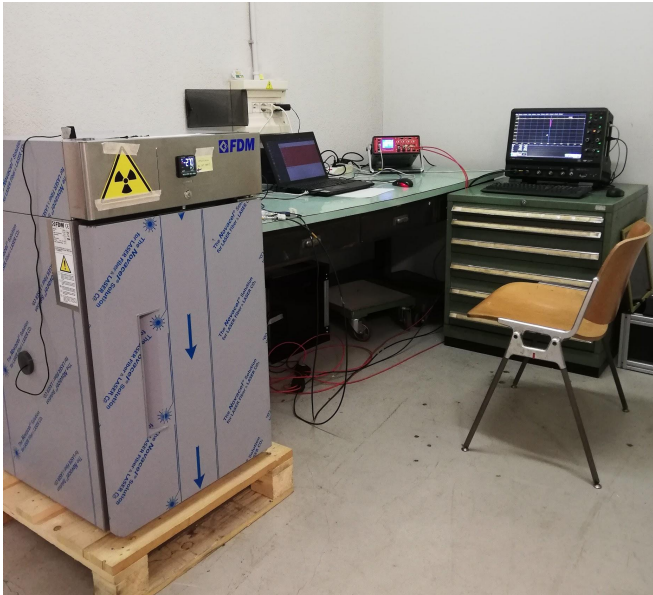
We also kindly acknowledge FBK for providing sensors and support during the testing campaign

BACKUP

Torino β -source setup



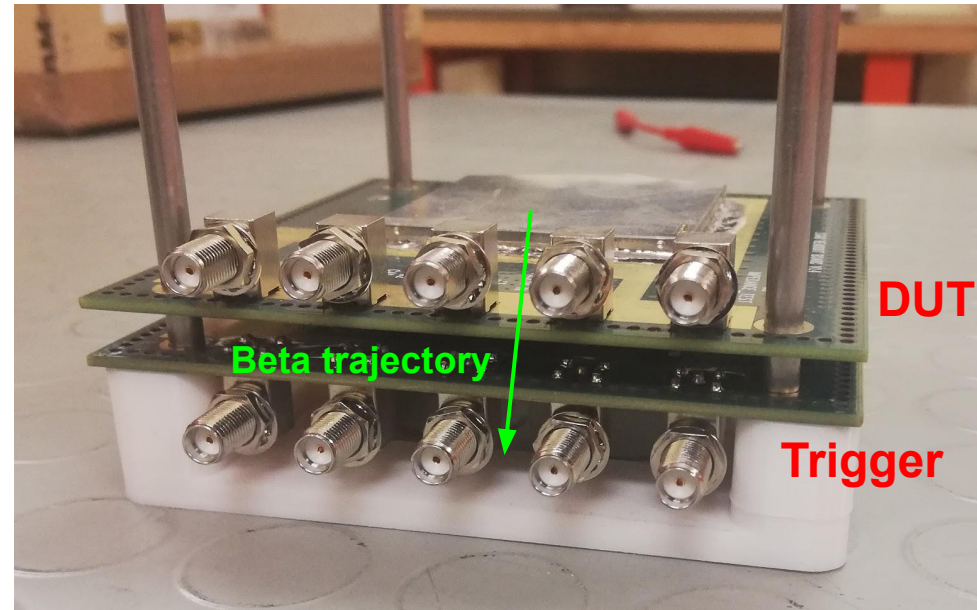
- DAQ and Analysis are fully automated
- Climate chamber
 - Can go down to -30°C with $\pm 0.1^{\circ}\text{C}$ uncertainty
 - $< 10\%$ humidity



Torino β -source setup



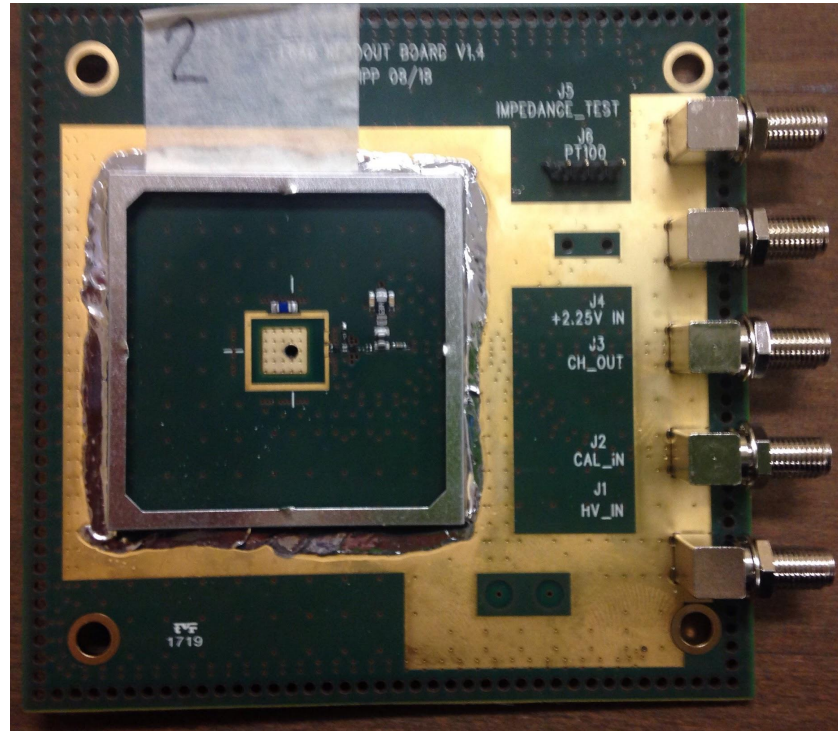
- DAQ and Analysis are fully automated
- Climate chamber
 - Can go down to -30°C with $\pm 0.1^{\circ}\text{C}$ uncertainty
 - $< 10\%$ humidity
- DUT + trigger Telescope, placed inside a specific structure (3d-printed) for alignment
- A trigger placed below the DUT ensures that we trigger only on MIPs
- Trigger: HPK1 $1 \times 3 \text{ mm}^2$ single pad
 - well known resolution
- $\sim 1\text{cm}$ of air between DUT & trigger



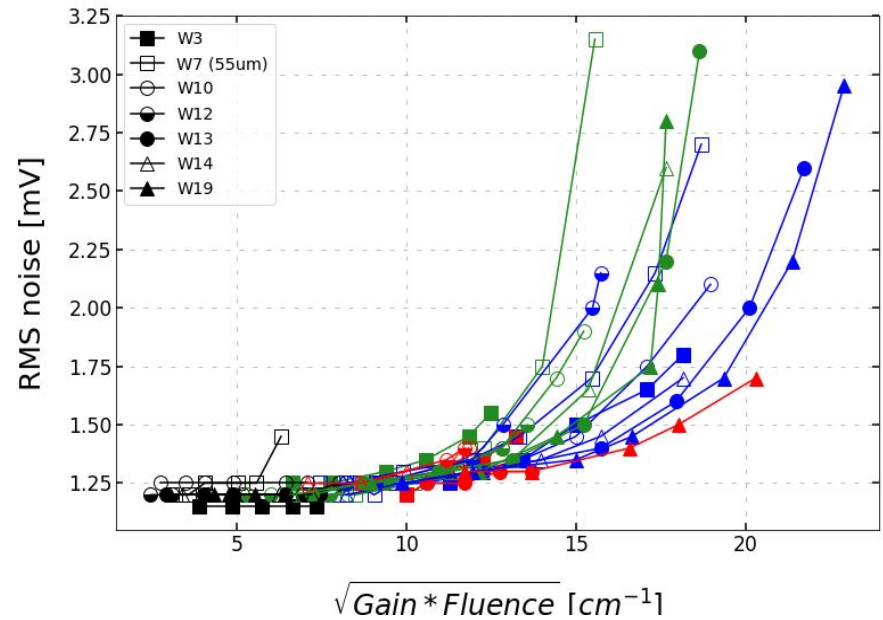
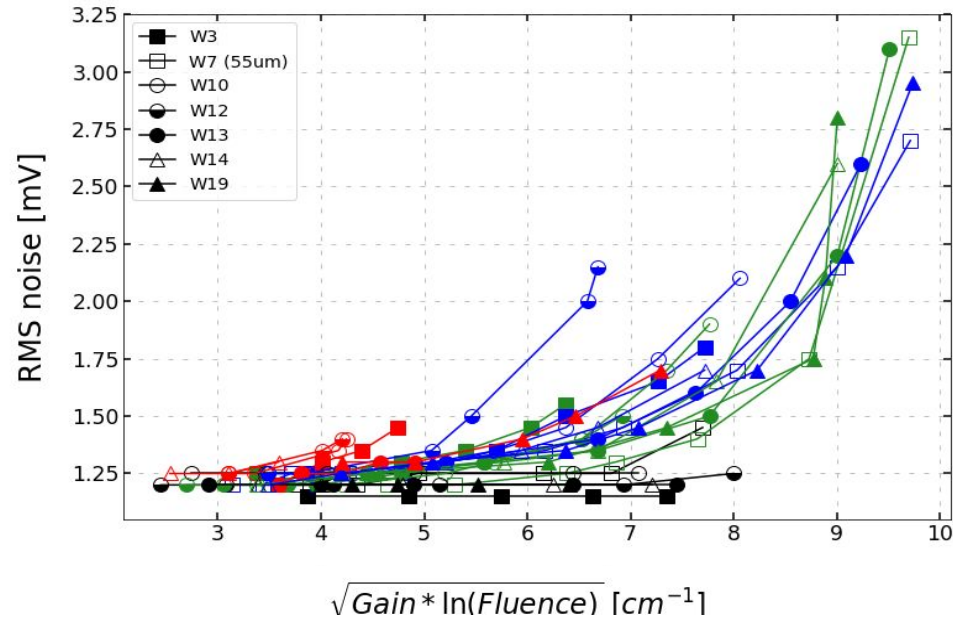
Torino β -source setup



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- $\sim 1\text{cm}$ of air between DUT & trigger
- “Santa Cruz” Read-out board made by Artel
 - single channel
 - x10 amplification (+ 20dB Cividec broadband amplifier)



Noise vs Bias: irradiated sensors



using $\ln(\text{fluence})$ gives a better trend

Weightfield2 Simulation

